PRDUCT SPECIFICATON TFT LCD MODULE Model: ELT240320ATP



2.8 inch TFT LCD with Touch Screen

This specification is subject to change without notice.

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1. LCM Specification

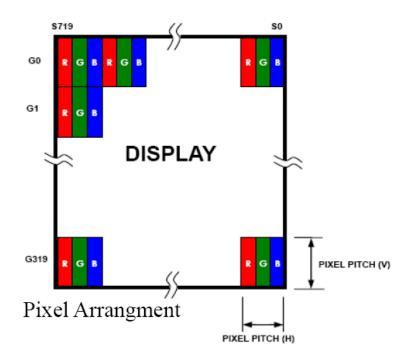
1.1 Description

ELT240320ATP is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT LCD panel, a drive IC, a FPC, and a WLED-backlight unit. The active display area is 2.8 inches diagonally measured and the native resolution is 240*RGB*320. Features of this product are listed in the following table.

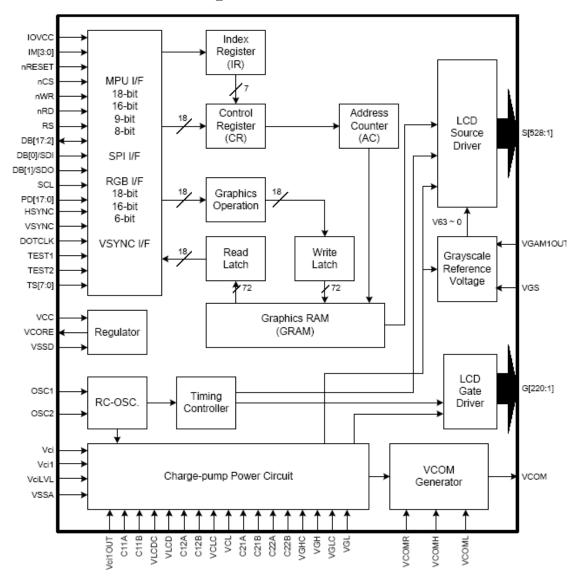
1.2 Functions & Features

Table 1.1 Module Functions & Features

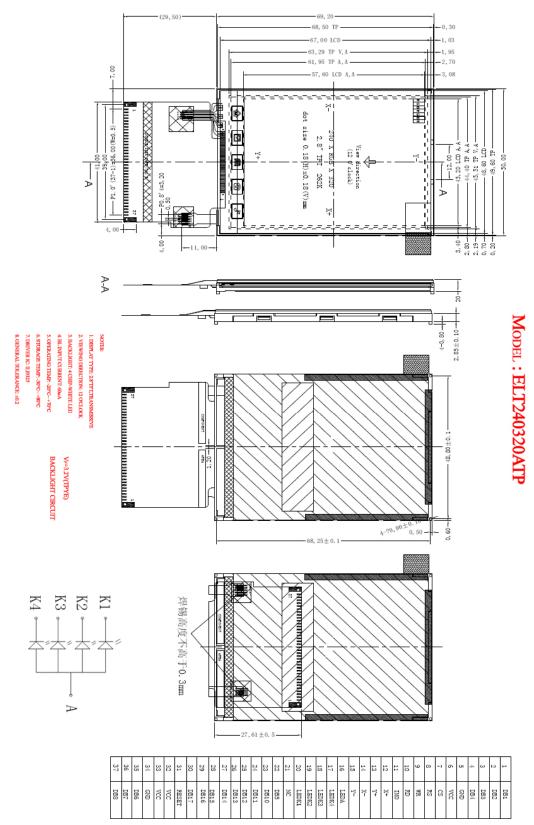
Parameter	Value	Unit
LCD Mode	a-Si TFT/transmissive	-
Color	262K	-
Display Resolution	240*RGB*320	pixels
OUTLINE DIMEMSIONS	50.00(W) x69.20(H) x4.05(T)	mm
Active Area(A.A)	43.20 (W) x 57.60(H)	mm
Pixel Arrangement	RGB-stripe	-
Viewing Direction	12 O'clock	
Display Mode	Normally white	
LCD Controller/Driver	ILI9325	-
IC Package Type	COG	-
MPU interface	Standard 8080 system18-/16-bit paraller	-
Power Supply Voltage	2.5~3.3	V
Back-light	White LED*4	pcs



2. Functional Block Diagram



3. Mechanical Specification



4. Electrical Units

4.1 Electrical Specification

4.1.1 Absolute Maximum Ratings

The absolute maximum ratings are list on Table 4.1. When used out of the absolute maximum ratings, the LCM may be permanently damaged. Using the LCM within the following electrical characteristics limit is strongly recommended for normal operation. If these electrical characteristic conditions are exceeded during normal operation, the LCM will malfunction and cause poor reliability.

Table 4.1 Module Absolute Maximun Ratings

Item	Symbol	Unit	Value	Note	
Power supply Voltage(1)	Vcc	V	-0.3~4.0		
Power supply Voltage(2)	Vci~VSS	ci~VSS V 2.5~3.3			
Power supply Voltage(3)	VGH~Vss	V	10~20		
Power supply Voltage(4)	VSS~VGH	V	10~20	-	
Inout Voltage	Vi	V	-0.3 to Vcc+0.3		
Operating Temperature	Тор	$^{\circ}$	-20 to +70		
Storage Temperature	Tst	$^{\circ}$	-30 to +80		

(VSS=0V)

4.2 Pin Descriptions

4.2.1 TFT LCD Panel interface FPC Pin Description

No.	Symbol	Functional	Remark
1	DB1	Data bus	
2	DB2	Data bus	
3	DB3	Data bus	
4	DB4	Data bus	
5	GND	Ground	
6	VCC	Power	
7	CS	Chip select pin of serial inter face	
8	RS	Data or command	
9	WR	Write signal	
10	RD	Read signal	
11	IMO	Interface mode select	
12	X+	Touch panel X+	
13	Y+	Touch panel Y+	
14	X-	Touch panel X-	
15	Y-	Touch panel Y-	
16	LED-A	LEDA	
17	LED-K4	LED K4	
18	LED-K3	LED K3	
19	LED-K2	LED K2	
20	LED-K1	LED K1	
21	NC	No connection	
22	DB5	Data bus	
23	DB10	Data bus	
24	DB11	Data bus	
25	DB12	Data bus	
26	DB13	Data bus	
27	DB14	Data bus	
28	DB15	Data bus	
29	DB16	Data bus	
30	DB17	Data bus	
31	REST	Reset din	
32	VCC	Power	
33	VCC	Power	
34	GND	Ground	
35	DB6	Data bus	
36	DB7	Data bus	
37	DB8	Data bus	

Note:

ELT240320ATP, LCD driver migrating from ILI9320 to ILI9325

- PIN IM0 when the IM0=0, it is for 16bit, and when the IM0=1, it is for 8bit.(DB10-DB17). By the way, there are three resistances on the screen, when you solder the R1, it is for 8bit, when you solder the R2, it is for 16bit, and when you solder the R3, it is controlled by the IM0 which you can select for either 8bit or 16bit.
- PIN 21 no connection

4.3 Electrical characteristics (Ta=25 $^{\circ}$ C)

4.3.1 DC characteristics

Table 4.2:DC Characteristic(Vcc=2.4~3.3V,Ta=0~60°C)

Table 4.2.DC Characteristic(v cc-2.4~5.5 v,1a=0~00 C)									
Item	Symbol	Unit	Test Conditon	Min	Тур.	Max	Note		
Input hight voltage	VIH	v	Vcc=1.8~3.3V	0.8xIOV CC	-	IOV cc	- 1		
Input low voltage	VIL	V	Vcc=1.8~3.3V	-0.3V	-	0.2xI OVc c	-		
I/O leakage current	ILi	mA	Vin=0~Vcc	-0.1	-	0.1	-		
Current consumption during normal operation(Vcc- VSS)	IOP(Vcc	mA	Vci=Vcc=2.8V,Ta=25 °C,fOSC=376KHz(Line)GRAM data=0000h,Frame rate=70Hz,REV=0,SAP =100,AP=100,DC0=00	-	100(VCC)	-	,		
Current consumption during normal operation (Vci –VSS)	IOP(Vci	mA	0,DC1=010,B/C=0,BT= 001,VC=001,VRH=001 1,VCM=10011,VDV=1 0000,VCOMG=1,CL=0 ,No panel load		100(VCC)	-			
Currentconsum ption during standby mode (Vcc –VSS)	Ist(Vcc)	mA		-	5	10			
Current consumption during standby mode (Vci –VSS)	Ist(Vci)	mA	Vcc=2.8V,Ta=25°C		5	10			
Output voltage deviation	-	mV	-	-	5	-	-		
Dispersion of the Average Output Voltage	V	mV	-	-	-	35	-		

4.4 Back-light Specification

Table 4.3 Back-light Specification

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Supply Voltage	VBAT	•	3.2	3.4	V	Note
Formard current	If	-	15	-	mA	
Power Consumption	PBL-		180	1	mW	Note

Note:

Table 4.4 Back-light Specification

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage	VF	Only	3.0	3.2	3.4	V
Supply Current	IF	Backlight		15x4=60)	mA
A Drightmass		Backlight				
Average Brightness	IV	Current	-	2800	-	Cd/m2
(With LCD dots all on)		IF=15mA				
CIE Color Coordinate	X	Backlight	0.24	_	0.29	
		Current				-
(Without LCD)	Y	IF=15mA	0.24	-	0.29	
		Backlight				
Uniformity	В	Current	80	-	-	(%)
		IF=15mA				
Color	White					

5. AC Characteristics

5.1.1 Clock Characteristics

Item	Symbol	Unit	Min.	Тур.	Max.	Test Condition
External clock frequency	Fcp	KHz	T.B.D	335	T.B.D	Vcc=2.4∼ 3.3V
External clock duty ratio	Duty	%	45	50	55	Vcc=2.4∼ 3.3V
External clock rise time	Trep	s	-	-	0.2	Vcc=2.4~ 3.3V
External clock fall time	Tfcp	s	-	-	0.2	Vcc=2.4~ 3.3V
R-C oscillation clock	fOSC	KHz	275	335	395	Rf=130KΩ, Vcc=2.8V

Table 5.1:Clock Characteristics (Vcc=2.4~3.3V)

5.1.2 8080 System (16bits)Bus Interface Timing Characteristics

	Ite	em	System	Unit	Min.	Тур.	Max.	Test Condition
Due or	vala tima	Write	tCYCW	ns	300	-	-	Figure5.1
Bus c	ycle time	Read	tCYCW	ns	500	-	-	Figure5.1
W	rite low-lev	el pulse width	PWLW	ns	40	-	-	Figure5.1
Re	ead low-lev	el pulse width	PWLR	ns	250	-	-	Figure5.1
Wı	rite high-lev	vel pulse width	PWHW	ns	30	-	-	Figure5.1
Re	ad high-lev	el pulse width	PWHR	ns	200	-	-	Figure5.1
W	rite / Read	rise / fall time	TWRr, TwRf	ns	-	-	25	Figure5.1
Setup	Write(RS	to NCS,E_NWR)	tAS	ns	5	-	-	Figure5.1
time	Read(RS	to NCS,RW_NRD)	tAS		5	-	-	Figure5.1
	Address	hold time	tAH	ns	5	-	-	Figure5.1
	Write data setup time			ns	15	-	-	Figure5.1
Write data hold time			tΗ	ns	15	-	-	Figure5.1
Read data delay time			tDDR	ns	-	-	80	Figure5.1
	Read data	hold time	tDHR	ns	5	-	-	Figure5.1

Table 5.2:Normal Write Mode(HWM=0)/(Vcc=2.4~3.3V)

	Item		System	Unit	Min.	Тур.	Max.	Test Condition
Du	s cycle time	Write	tCYCW	ns	100		-	Figure5.1
Du	s cycle time	Read	tCYCW	ns	500	•	-	Figure5.1
W	rite low-level pul	se width	PWLW	ns	40	•	-	Figure5.1
Re	ead low-level pul	se width	PWLR	ns	250	-	-	Figure5.1
Wı	rite high-level pu	lse width	PWHW	ns	30	-	-	Figure5.1
Read high-level pulse width			PWHR	ns	200	-	-	Figure5.1
V	Write Read/ rise/f	all time	WRr, tWRF	ns	-	-	25	Figure5.1
Setup	Write(RS to N	CS,E_NWR)	+ A C	ns	5	-	-	Figure5.1
time	Read(RS to NC	S,RW_NRD)	tAS	ns	5	•	-	Figure5.1
	Address hold t	ime	tAH	ns	5	-	-	Figure5.1
Write data setup time			tDSW	ns	15		-	Figure5.1
Write data hold time			tΗ	ns	20	-	-	Figure5.1
Read data delay time			tDDR	ns	-	-	200	Figure5.1
	Read data hold	time	tDHR	ns	5	•	-	Figure5.1

Table 5.3 High-Speed Write Mode (HWM=1)/(Vcc=2.4~3.3V)

5.1.3 80-system(8Bits) Bus Interface Timing Characteristics

	Item		Symbol	Unit	Min.	Тур.	Max.	Test Condition
Du	s cycle time	Write	tCYCW	ns	300	•	•	Figure5.1
Du	s cycle time	Read	tCYCW	ns	500	•	ı	Figure 5.1
W	rite low-level pul	se width	PWLW	ns	40	•	•	Figure 5.1
Re	ead low-level pul	se width	PWLR	ns	250	-	-	Figure 5.1
Wı	rite high-level pu	lse width	PWHW	ns	30		•	Figure 5.1
Read high-level pulse width			PWHR	ns	200		-	Figure5.1
V	Vrite Read/ rise/f	all time	WRr, tWRF	ns	-	-	25	Figure5.1
Setup	Write(RS to N	CS,E_NWR)	tAS	ns	5	-	-	Figure5.1
time	Read(RS to NC	S,RW_NRD)	iAs	ns	5	-	-	Figure 5.1
	Address hold t	ime	tAH	ns	5	-	-	Figure5.1
Write data setup time			tDSW	ns	15	•	•	Figure 5.1
Write data hold time			tΗ	ns	20	•	•	Figure5.1
Read data delay time			tDDR	ns	-	•	120	Figure5.1
	Read data hold	time	tDHR	ns	5	-	-	Figure5.1

Table 5.4 Normal Write Mode(HWM=0)/(Vcc=2.4~3.3V)

5.2 Timing Characteristic

5.2.1 8080 System Bus Operation

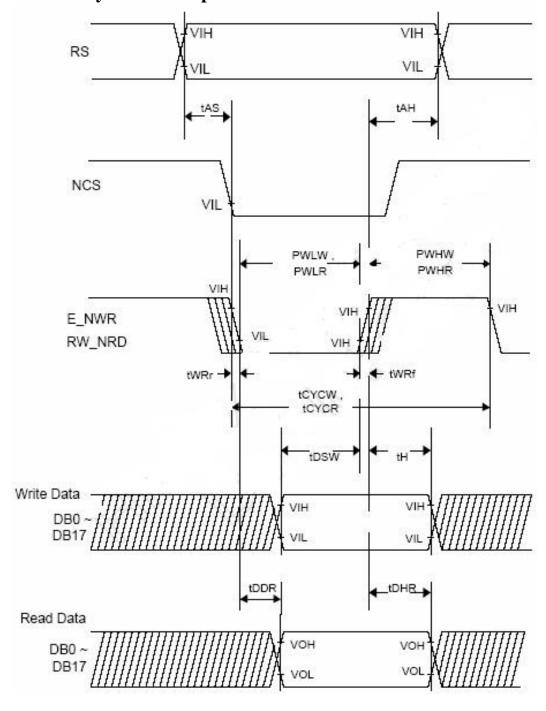


Figure 5.1:8080 System Bus Timing

6. Optical Specifications

Itama		Symbol	Conditions	Spe	ecification	ons	Linit	Note	
Item	iteiii		Conditions	Min.	Тур.	Max.	Unit	Note	
Transmittance)	T%			6.0		%		
Contrast Ratio)	CR		150	250	-			
Response Tin	20	T _R		-	15	30	ms	All left side data	
Response IIII	ie .	T_F		-	35	50	ms	are based on	
	Red	X_R		0.610	0.640	0.670		CMO's following	
	Reu	YR	∃ Viewing normal angle ⊢	0.314	0.344	0.374		condition	
	Green	X _G		0.268	0.298	0.328		Type 6 NTSC: 58%	
Chromoticity	Green	Y_G	0x = 0y =0	0.553	0.583	0.613			
Chromaticity	Blue	X _B		0.102	0.132	0.162		LC: 5001 Light : C light	
	Diue	Y _B		0.107	0.137	0.167		(Machine:BM5A)	
	White	X_W		0.282	0.312	0.342		Polarizer without	
	vvriite	Y_W		0.319	0.349	0.379		DBEF	
		θ_{X+}		-	45			Reference Only	
Viewing	Hor.	θ _X .	Center		45		doa		
Angle	\/a=	θ _{Y+}	CR≥10	-	35		deg.		
	Ver.	θ _Υ .		-	15				

NOTE (1)**Definition of Contrast Ratio**(CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) =L63 / L0

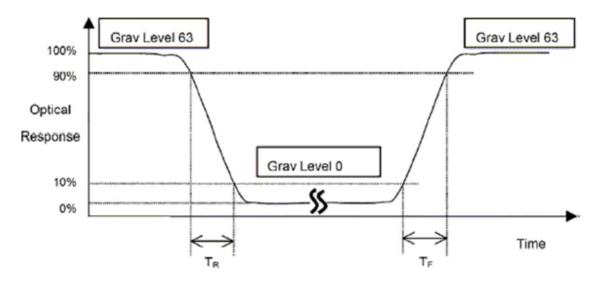
L63: Luminance of gray level 63

L0: Luminance of gray level 0

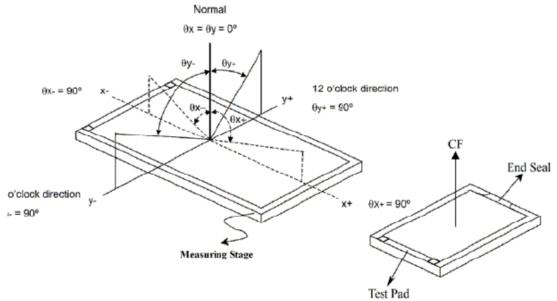
CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (2) Definition of Response Time (TR, TF):



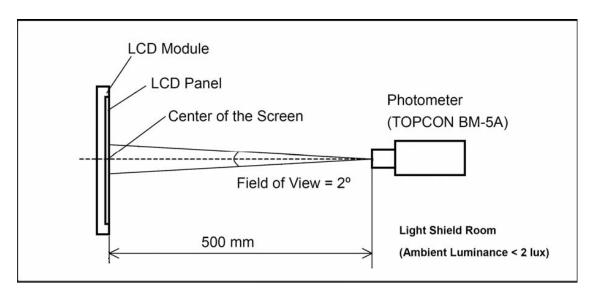
Note (3) Definition of viewing Angle:



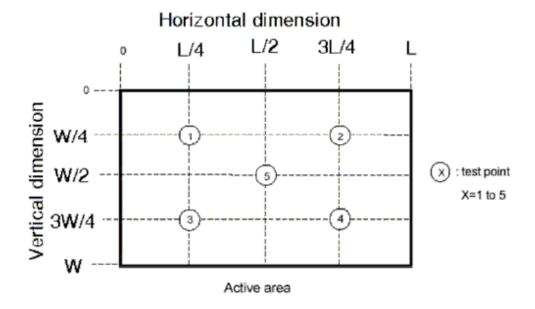
*** The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid Abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



Note(5) Horizontal Dimension



7. Reliability Test Items

No.	Test Item	Test Condition	Check Time
1	High temp storage	T= 80°C	240 hrs
2	Low temp storage	T= -30℃	240 hrs
3	High temp operation	T= 70°C	240 hrs
4	Low temp operation	T= -20°C	240 hrs
5	High temp & high humidity	T=60°C H=90%	240 hrs

Reliability Test Criteria:

Display function should be no change under normal operating condition.

8. Package (TBD)

Please contact for more information.

9. Handling Precautions

9.1 Safety

The liquid crystal in the LCD is poisonous. Keep away from your mouth and eyes. If the liquid crystal contacts with your skin, mouse or clothes, use soap to wash it off immediately.

9.2 Handling

- **i.** The LCD panel is made by thin glass. Prevent the panel from mechanical shock or putting excessive force on its surface.
- **ii.** The polarizer attached on the display is very easy to be damaged, handle it with special attention.
- **iii.** To avoid contamination on the display surface, do not touch the display surface with bare hands.
- **iv.** The transparent electrodes may be disconnected if you use the LCD panel under dew-condensing environment.
- **v.** The characteristics of the semiconductor devices may be affected when they are exposed to light, possibly resulting in malfunctioning of the ICs. To prevent such malfunctioning of the ICs, make sure the application and the mounting of the panel are designed so that the IC is not exposed to light.

9.3 Static Electricity

Ground soldering iron tips, tools and testers when you operate. Also ground your body when handling the products and store the products in an anti-electrostatic container.

9.4 Storage

Store the products in a dark place where the temperature is within the range of 25±10 and with low humidity (65%RH or less). Do not store the LCD product in an atmosphere containing organic solvents or corrosive gases.

9.5 Cleaning

Do not wipe the polarizer with dry cloth, as it might cause scratching. Wipe the polarizer with a soft cloth soaked with petroleum IPA. Other chemical might damage the panel.

